GHz



MXP7A02 – 1x4 Array 3.125 Gbps

GaAs PIN Photo Diode

ENGINEERING SPECIFICATION

DESCRIPTION

Microsemi's GaAs PIN Photo Diode chips The MXP7000 series of photo diodes are ideal for high bandwidth 850nm optical networking applications.

The device series offers superior noise performance and sensitivity due to their construction and passivation.

Every wafer of each lot is extensively tested for responsivity and capacitance. Dark current is tested on 100% of the devices. Reliability is demonstrated by high temperature reverse bias testing on each wafer.

are currently offered in die form allowing manufacturers the versatility of custom assembly configurations.

This device is ideal for manufacturers of optical receivers, transponders, optical transmission modules and combination PIN photo diode - transimpedance amplifier.

KEY FEATURES

- High Responsivity
- Low Dark Current
- High Bandwidth
- Anode/Cathode on Illuminated Side

APPLICATIONS

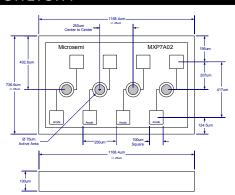
- Short Reach Optical Networks
- 10Gigabit Ethernet, Fibre Channel

BENEFITS

- Large Wirebond Contact Pad
- Low Contact Resistance
- Low Crosstalk between Photo Diodes

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

PRODUCT HIGHLIGHT



CHARACTERISTICS

Test conditions (unless otherwise noted): $T_A = 25^{\circ}C$, $V_R = 5$ Volts

Parameter	Symbol	Test Conditions	MXP7A02			Units
	Symbol		Min	Тур	Max	Ullits
MAXIMUM RATINGS						
Operating Temperature Range	T _{OP}		-40		+100	°C
Storage Temperature Range	T _{STG}		-60		+125	°C
Maximum Soldering Temperature		10 seconds maximum at temperature			+260	°C
▶ ELECTRICAL CHARACTERISTICS (each	photo diode)					
Active Area Diameter				100		μm
Responsivity	R	V _R = 5V, λ= 850nm		0.45		A/W
Dark Current	I_{D}	V _R = 5V		0.05		nA
Breakdown Voltage	BV_R	$I_R = 1\mu A$		25		Volts
Capacitance	С	V _R = 5V		0.2		рF

 $V_R = 5V, \lambda = 850nm$

Bandwidth



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PRECAUTIONS FOR USE

ESD protection is important. Standard ESD protection procedures should be employed whenever handling GaAs PIN photo diode.